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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

JC997 U.S. PTO
10/087318
03/01/02

Applicant: Gary J. Hydock

Serial No.:

Filed:

For: MODULAR RADIANT HEAT PANEL SYSTEM

INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

S i r:

Applicant submits this Information Disclosure Statement, which includes attached Form PTO/SB/08A, within the time period set forth in 37 C.F.R. 1.97(b).

Applicant submits patents, of which they are aware that they believe may be material to the examination of this application, and in respect of which, there may be a duty to disclose.

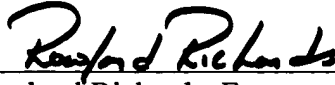
Legible copies of all items listed in the attached Form PTO/SB/08A accompany this Information Disclosure Statement.

The filing of this Information Disclosure Statement shall not be construed as a representation that a search has been made (37 C.F.R. 1.97(g)), an admission that the information cited is, or is considered to be, material to patentability (37 C.F.R. 1.97(h)), or that no other material information exists.

The filing of this Information Disclosure Statement shall not be construed as an admission against interest in any manner.

Respectfully submitted,

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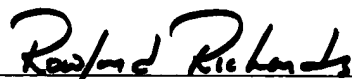
Buffalo, New York

Dated: March 1, 2002

CERTIFICATE OF MAILING

I certify that this correspondence is being deposited with the United States Postal Service as first class mail, postage prepaid, in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, this 1st day of March, 2002.

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